



In the United States Patent and Trademark Office

Serial Number: 10/728,797

Application. Filed: December 8, 2003

Applicant: Kia Silverbrook

Application Title: Thermal Expansion Relief for Printhead Assembly

Examiner/GAU: Jannelle M. Lebron 2861

Dated June 20, 2006

At: BALMAIN, NSW

Docket No. ZF133US

### AMENDMENT A

Commissioner for Patents  
Washington, District of Columbia 20231

Dear Sir:

In response to the Office Action of March 27, 2006, please amend the above-identified application as follows:

**Amendments to the Specification** begin on page 2 of this paper. The Applicant submits that these amendments introduce no new matter.

**Amendments to the Abstract** begin on page 3 of this paper. The Applicant submits that these amendments introduce no new matter.

**Amendments to the Claims** begin on page 4 of this paper. The Applicant submits that these amendments introduce no new matter.

**Remarks/Arguments** begin on page 5 of this paper.

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